

**General Description:**

Schottky Barrier Diodes make use of the rectification effect of a metal to silicon barrier. They are ideally suited for high frequency rectification in switching regulators & converters. This device offers a low forward voltage performance in a power surface mount package in applications where size and weight are critical.

**Features:**

- Compact surface mount package with J-bend leads (SMC).
- 3.0 Watt Power Dissipation package.
- 3.0 Ampere, forward voltage less than 500 mv

**Ordering:**

- 13 inch reel (330 mm); 16 mm Tape; 3,000 units per reel.

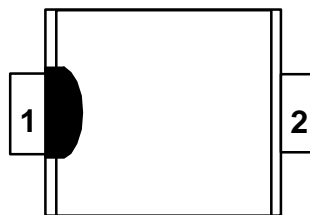
**Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

Parameter	Value	Units
Storage Temperature	-65 to +150	°C
Maximum Junction Temperature	-65 to +125	°C
Repetitive Peak Reverse Voltage ( $V_{RRM}$ )	20	V
Average Rectified Forward Current ( $T_L = 100^\circ\text{C}$ )	3.0	A
( $T_L = 90^\circ\text{C}$ )	4.0	A
Surge Non Repetitive Forward Current (Half wave, single phase, 60 Hz)	80	A
Junction to Case for Thermal Resistance ( $R_{\theta JL}$ )	11	°C/W

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

**SMC Package  
(DO-214AB)**

Top Mark: B32

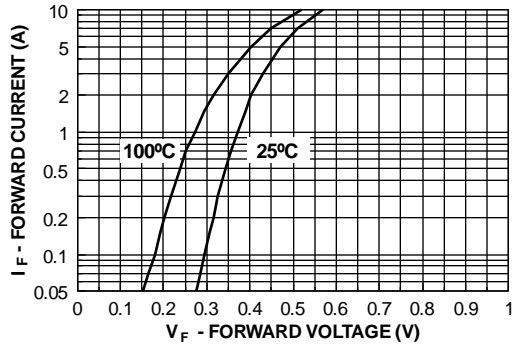


**Actual Size**

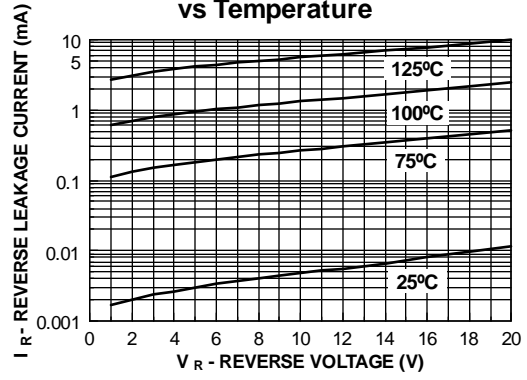
**Electrical Characteristics** TA = 25°C unless otherwise noted

SYM	CHARACTERISTICS	MIN	MAX	UNITS	TEST CONDITIONS
$I_R$	Reverse Leakage Current PW 300 us, $\leq 2\%$ Duty Cycle		2.0 20	mA mA	$V_R = 20 \text{ V}; T_j = 25^\circ\text{C}$ $V_R = 20 \text{ V}; T_j = 100^\circ\text{C}$
$V_F$	Forward Voltage PW 300 us, $\leq 2\%$ Duty Cycle		500	mV	$I_F = 3.0 \text{ A}; T_j = 25^\circ\text{C}$

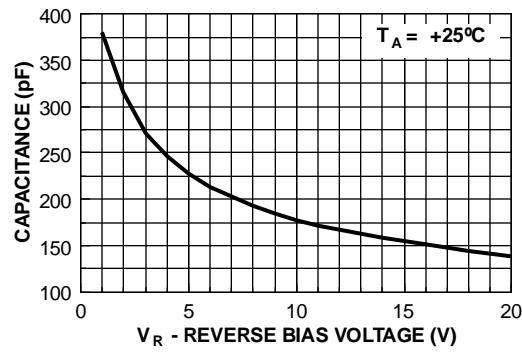
**Forward Voltage vs Temperature**



**Reverse Leakage Current vs Temperature**



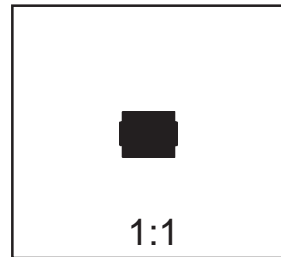
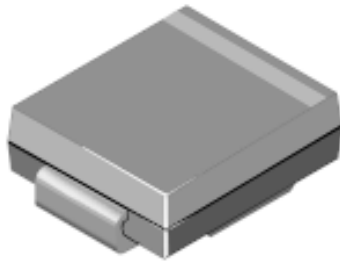
**Capacitance vs. Reverse Bias Voltage**



# SMC/DO-214AB Package Dimensions



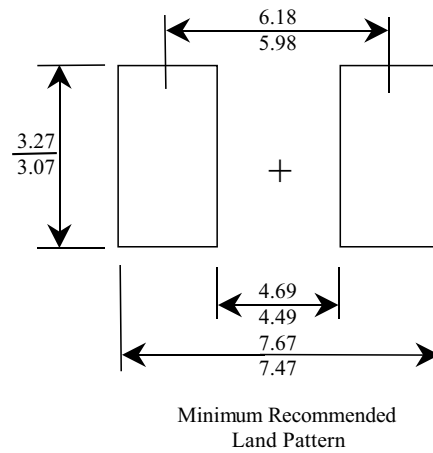
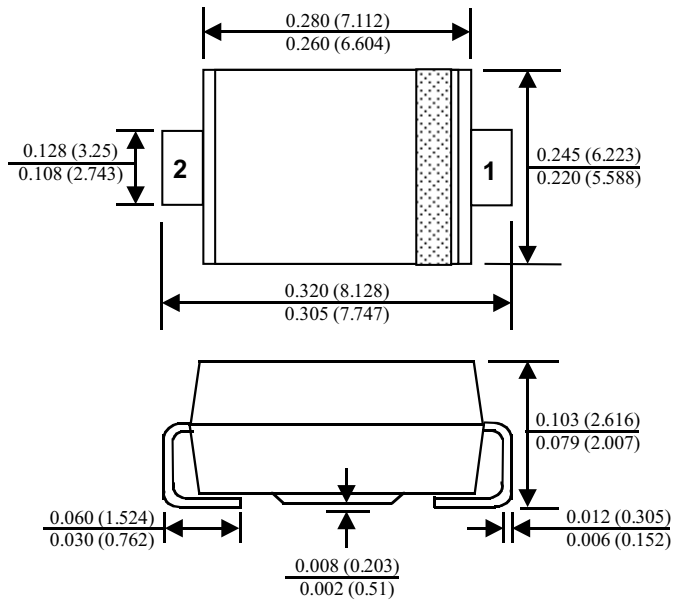
## SMC/DO-214AB (FS PKG Code P7)



Scale 1:1 on letter size paper

Dimensions shown below are in:  
inches [millimeters]

Part Weight per unit (gram): 0.21



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CROSSVOLT™	POP™	UHC™
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GTO™	SuperSOT™-6	

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## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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